



SEMITRANTM 2N

Superfast NPT-IGBT Modules

SKM 195GB063DN

SKM 195GAL063DN

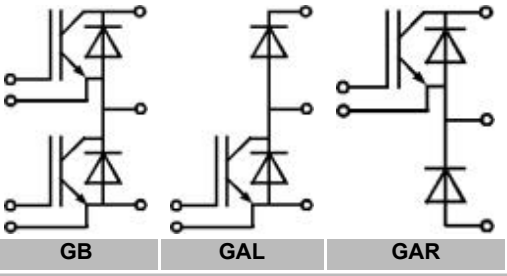
SKM 195GAR063DN

Features

- N channel, homogeneous Silicon structure (NPT - Non Punch-through IGBT)
- Low tail current with low temperature dependence
- High short circuit capability, self limiting
- Pos. temp.-coeff. of V_{CEsat}
- Low inductance case
- Fast & soft inverse CAL diodes
- Without hard mould
- Large clearance (10 mm) and creepage distances (20 mm)

Typical Applications

- Switching (not for linear use)
- Switched mode power supplies
- AC inverter drives
- UPS uninterruptable power supplies



Absolute Maximum Ratings $T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	Values	Units
IGBT			
V_{CES}		600	V
I_C	$T_c = 25\text{ (85)}\text{ }^\circ\text{C}$	250 (190)	A
I_{CRM}	$t_p = 1\text{ ms}$	400	A
V_{GES}		± 20	V
T_{vj} (T_{stg})	$T_{OPERATION} \leq T_{stg}$	- 40 ... + 150 (125)	$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500	V
Inverse diode			
I_F	$T_c = 25\text{ (80)}\text{ }^\circ\text{C}$	200 (140)	A
I_{FRM}	$t_p = 1\text{ ms}$	400	A
I_{FSM}	$t_p = 10\text{ ms}$; sin.; $T_j = 150\text{ }^\circ\text{C}$	1400	A

Characteristics $T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified					
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 4\text{ mA}$	4,5	5,5	6,5	V
I_{CES}	$V_{GE} = 0$, $V_{CE} = V_{CES}$, $T_j = 25\text{ (125)}\text{ }^\circ\text{C}$		0,2	0,6	mA
$V_{CE(TO)}$	$T_j = 25\text{ (125)}\text{ }^\circ\text{C}$		1,05 (1)		V
F_{CE}	$V_{GE} = 15\text{ V}$, $T_j = 25\text{ (125)}\text{ }^\circ\text{C}$		5,25 (7)		m??
$V_{CE(sat)}$	$I_C = 200\text{ A}$, $V_{GE} = 15\text{ V}$, chip level		2,1 (2,4)	2,5 (2,8)	V
C_{ies}	under following conditions		11,2		nF
C_{oes}	$V_{GE} = 0$, $V_{CE} = 25\text{ V}$, $f = 1\text{ MHz}$		1,25		nF
C_{res}			0,75		nF
L_{CE}				25	nH
R_{CC+EE}	res., terminal-chip $T_c = 25\text{ (125)}\text{ }^\circ\text{C}$		0,75 (1)		m
$t_{d(on)}$	$V_{CC} = 300\text{ V}$, $I_C = 200\text{ A}$		120		ns
t_r	$R_{Gon} = R_{Goff} = 8$, $T_j = 125\text{ }^\circ\text{C}$		85		ns
$t_{d(off)}$	$V_{GE} = \pm 15\text{ V}$		460		ns
t_f			50		ns
E_{on} (E_{off})			11,5 (7,5)		mJ
Inverse diode					
$V_F = V_{EC}$	$I_F = 150\text{ A}$; $V_{GE} = 0\text{ V}$; $T_j = 25\text{ (125)}\text{ }^\circ\text{C}$		1,45 (1,35)	1,7	V
$V_{(TO)}$	$T_j = 25\text{ (125)}\text{ }^\circ\text{C}$			0,9	V
F_T	$T_j = 25\text{ (125)}\text{ }^\circ\text{C}$		4	5,5	m
I_{RRM}	$I_F = 200\text{ A}$; $T_j = 125\text{ () }^\circ\text{C}$		75		A
Q_{tr}	$di/dt = A/\mu\text{s}$		13		μC
E_{tr}	$V_{GE} = V$				mJ
Thermal characteristics					
$R_{th(j-c)}$	per IGBT			0,13	K/W
$R_{th(j-c)D}$	per Inverse Diode			0,3	K/W
$R_{th(c-s)}$	per module			0,05	K/W
Mechanical data					
M_s	to heatsink M6		3	5	Nm

M _t	to terminals M5	2,5	5	Nm
w			160	g

Diagrams

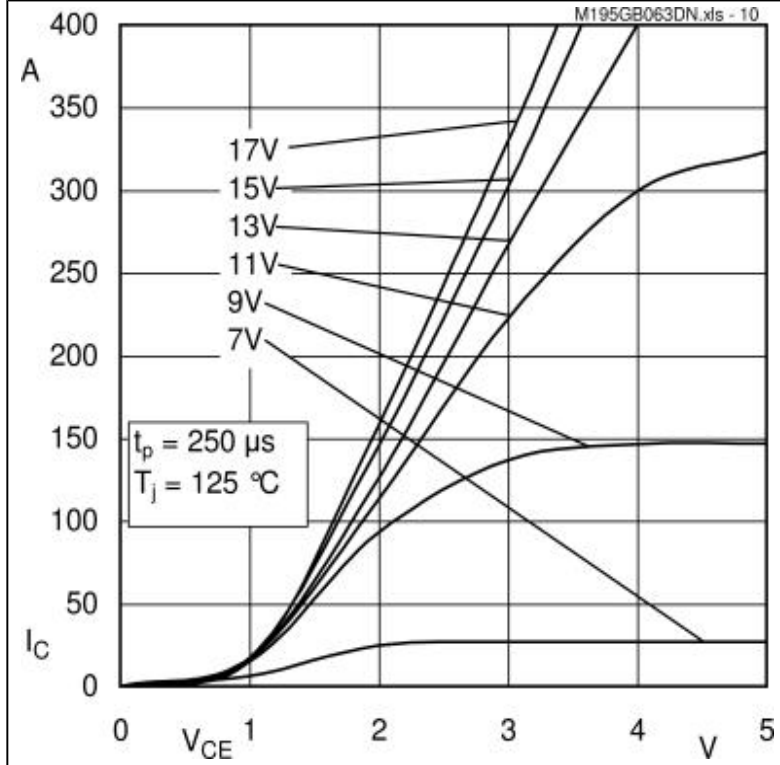


Fig. 1 Typ. output characteristic, inclusive $R_{CC}+EE'$

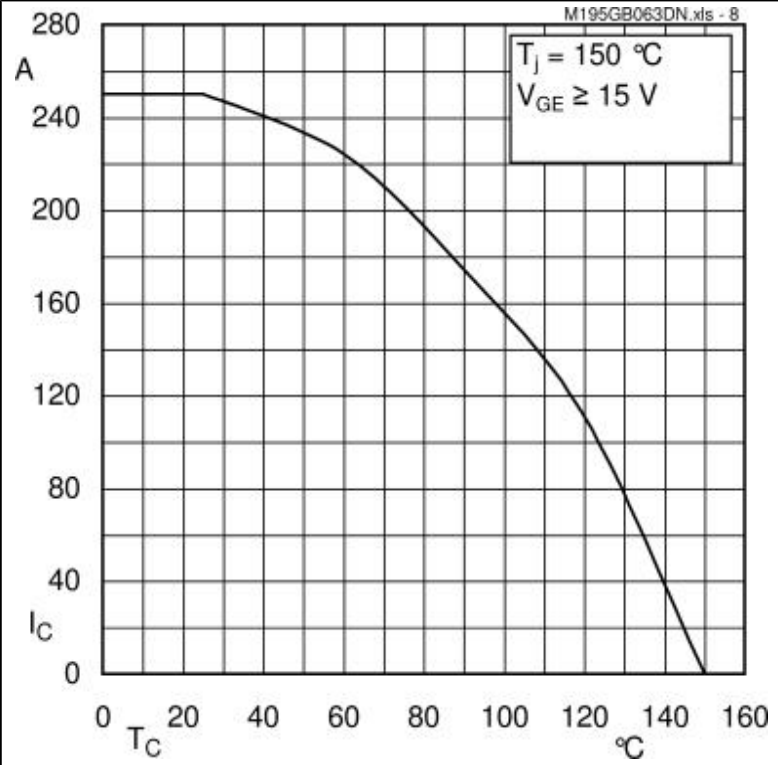


Fig. 2 Rated current vs. temperature $I_C = f(T_C)$

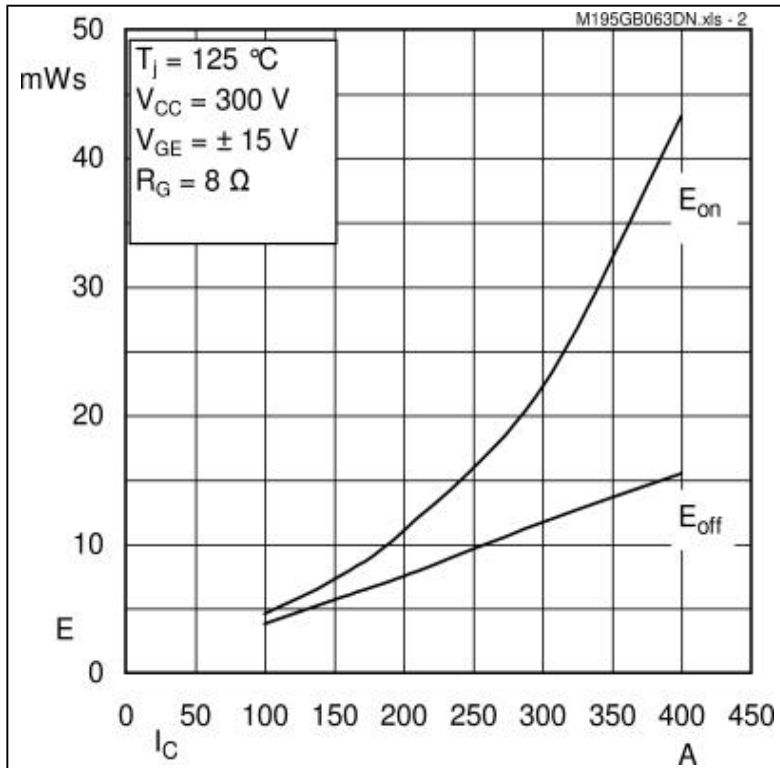


Fig. 3 Typ. turn-on /-off energy = $f(I_C)$

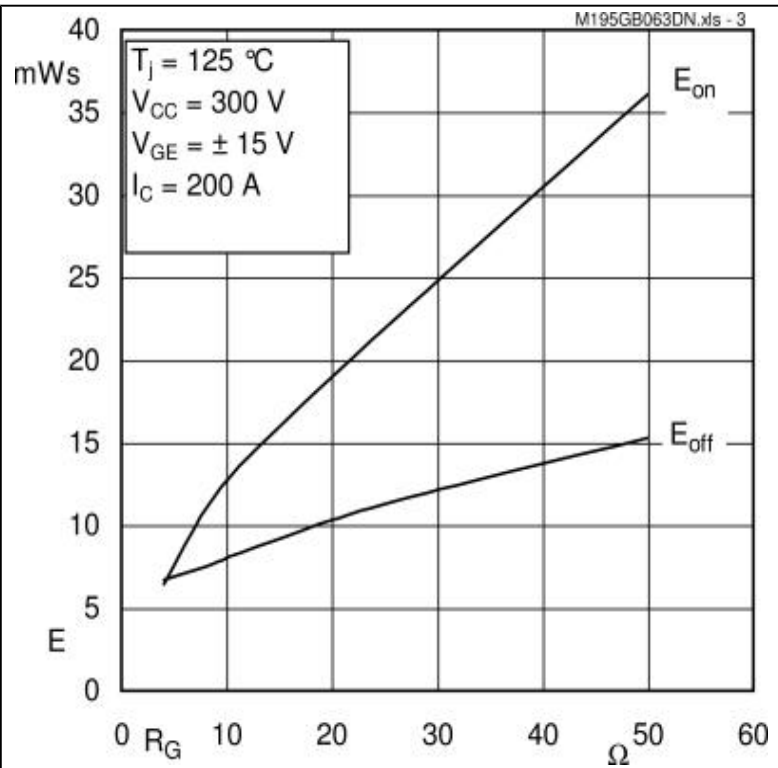


Fig. 4 Typ. turn-on /-off energy = $f(R_G)$

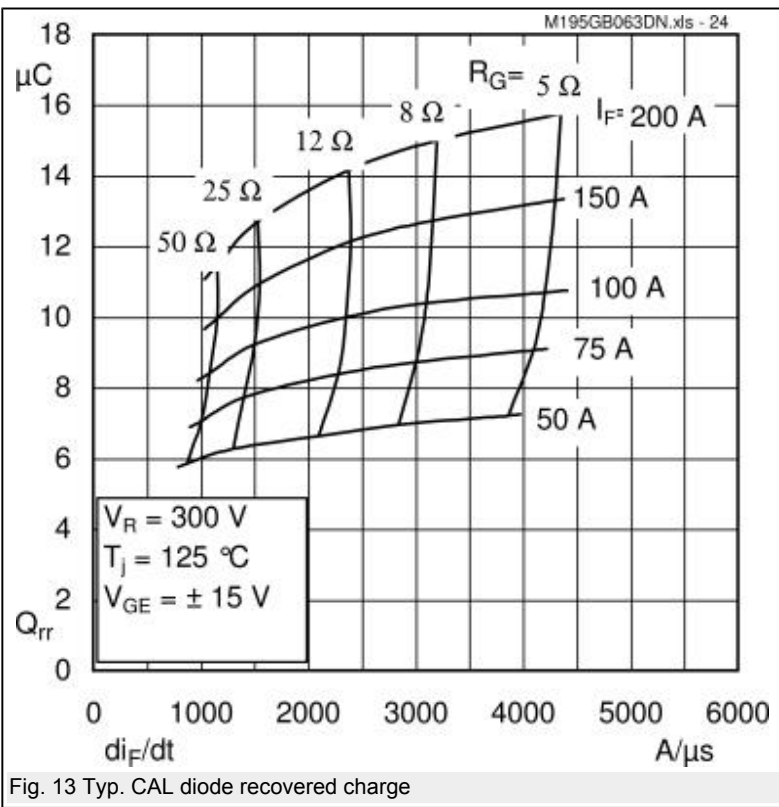


Fig. 13 Typ. CAL diode recovered charge

Cases / Circuits

